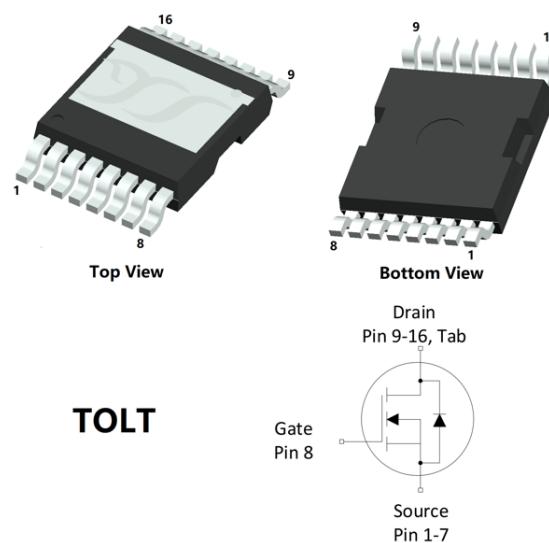


**N-Channel Enhancement Mode Field Effect Transistor****Product Summary**

- $V_{DS}$  100V
- $I_D$  340A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ )  $<1.7m\Omega$
- 100% EAS Tested
- 100%  $\nabla V_{DS}$  Tested

**General Description**

- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

**Applications**

- High power inverter system
- BMS appliances

**■ Absolute Maximum Ratings ( $T_J=25^\circ C$  unless otherwise noted)**

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	100	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current (Note 1,2 )	Steady-State	$T_A=25^\circ C, V_{GS}= 10V$	34	A
		$T_A=100^\circ C, V_{GS}= 10V$	24	
Continuous Drain Current (Note 1,3 )	Steady-State	$T_c=25^\circ C, V_{GS}= 10V$	340	A
		$T_c =100^\circ C, V_{GS}= 10V$	240	
Pulsed Drain Current	$T_c=25^\circ C, t_p=100\mu s$	$I_{DM}$	1360	A
Avalanche energy	$V_G=10V, R_G=25\Omega, L=5mH, IAS=33A$	EAS	2722.5	mJ
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^\circ C$	4.1	W
		$T_A=100^\circ C$	2	
Total Power Dissipation (Note 1,3 )	Steady-State	$T_c=25^\circ C$	416	
		$T_c =100^\circ C$	208	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+175	°C

**■ Thermal resistance**

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{\theta JA}$	30	36	°C/W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.3	0.36	



# YJTL1D7G10HQ

## ■ Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	100	-	-	V
		$V_{\text{GS}}=0\text{V}, I_{\text{D}}=10\text{mA}$	100	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	100	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	2.6	4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	-	1.28	1.7	$\text{m}\Omega$
Diode Forward Voltage	$V_{\text{SD}}$	$I_{\text{S}}=20\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.2	V
Gate resistance	$R_{\text{G}}$	f=1MHz	-	1.45	-	$\Omega$
Maximum Body-Diode Continuous Current	$I_{\text{S}}$		-	-	340	A
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	10700	-	pF
Output Capacitance	$C_{\text{oss}}$		-	2010	-	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	35	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=30\text{A}$	-	166	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	34	-	
Gate-Drain Charge	$Q_{\text{gd}}$		-	49	-	
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_{\text{F}}=30\text{A}, di/dt=100\text{A/us}$	-	167	-	nC
Reverse Recovery Time	$t_{\text{rr}}$		-	92	-	ns
Turn-on Delay Time	$t_{\text{D(on)}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=50\text{V}, I_{\text{D}}=30\text{A}$ $R_{\text{GEN}}=4.5\Omega$	-	30	-	ns
Turn-on Rise Time	$t_{\text{r}}$		-	65	-	
Turn-off Delay Time	$t_{\text{D(off)}}$		-	121	-	
Turn-off fall Time	$t_{\text{f}}$		-	107	-	

Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of  $R_{\text{GA}}$  is measured with the device mounted on the 40mm\*40mm\*1.1mm single layer FR-4 PCB board with 1 in<sup>2</sup> pad of 2oz. Copper, in the still air environment with TA =25°C. The maximum allowed junction temperature of 175°C. The value in any given application depends on the user's specific board design.
- Thermal resistance from junction to soldering point (on the exposed drain pad).

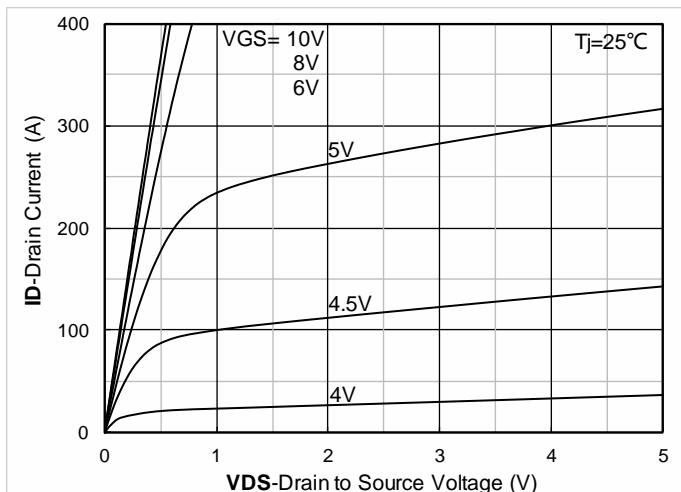
**■Typical Electrical and Thermal Characteristics Diagrams**

Figure 1. Output Characteristics

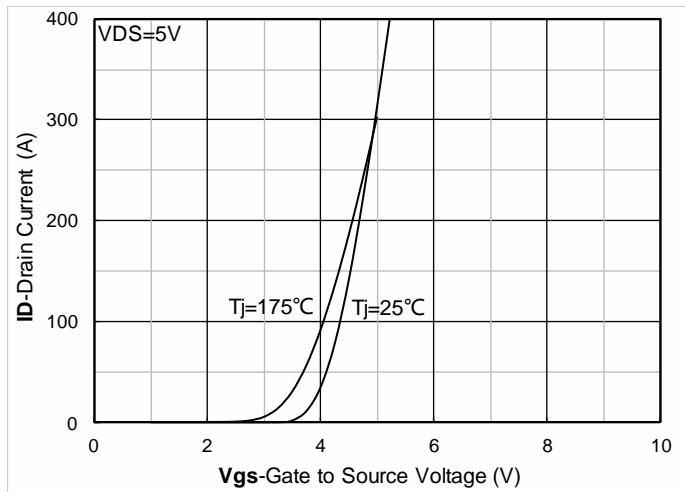


Figure 2. Transfer Characteristics

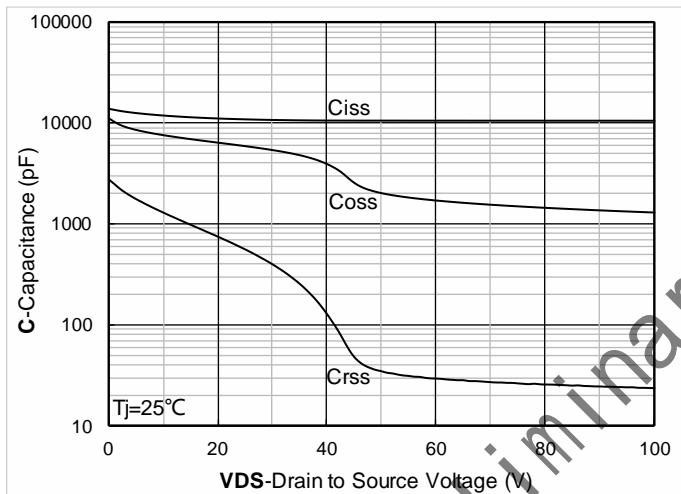


Figure 3. Capacitance Characteristics

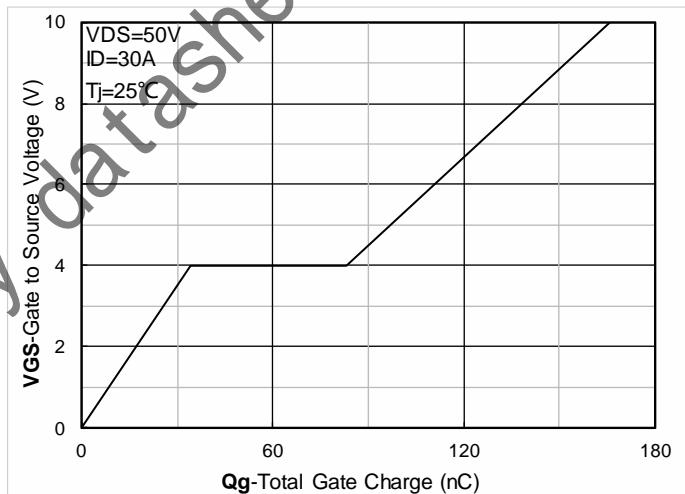


Figure 4. Gate Charge

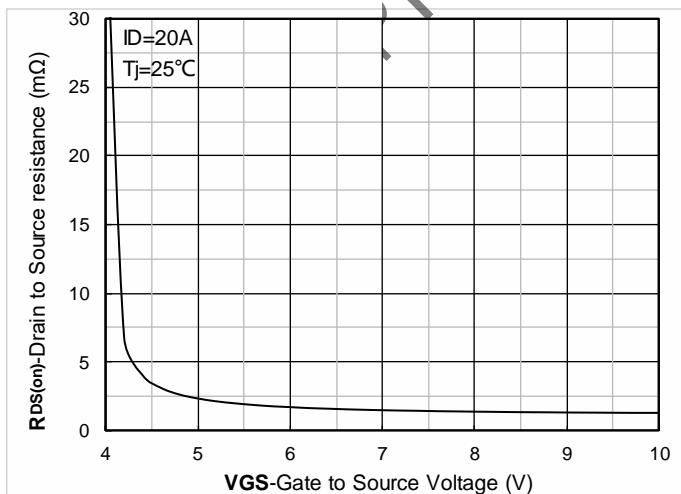


Figure 5. On-Resistance vs Gate to Source Voltage

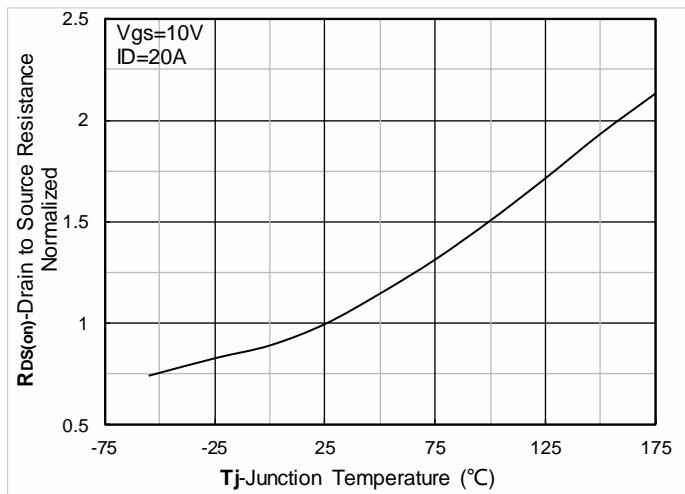


Figure 6. Normalized On-Resistance

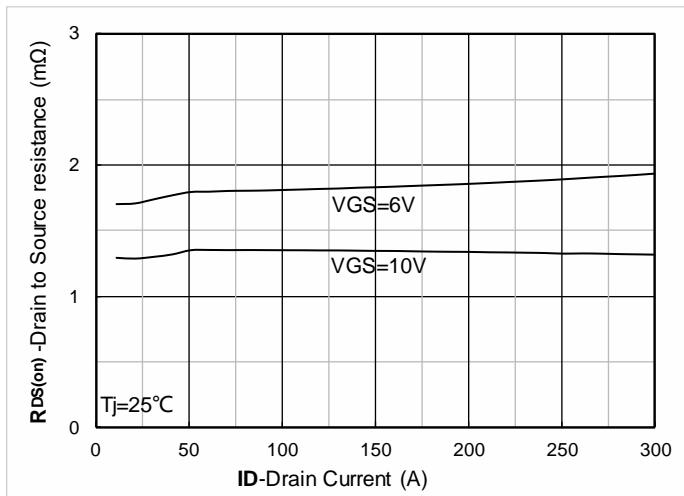


Figure 7. RDS(on) VS Drain Current

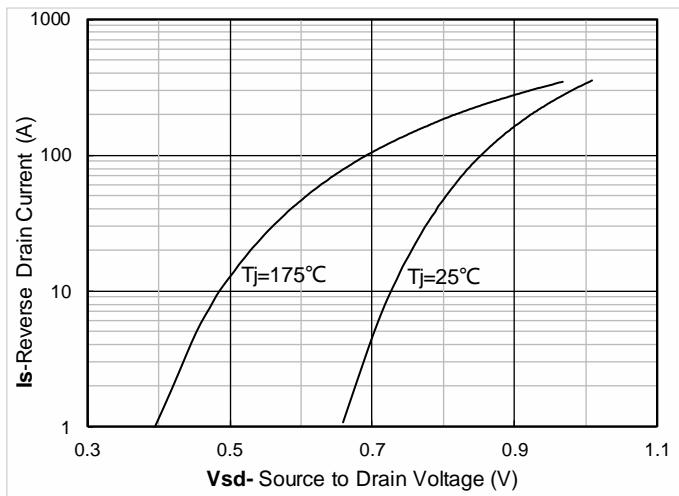


Figure 8. Forward characteristics of reverse diode

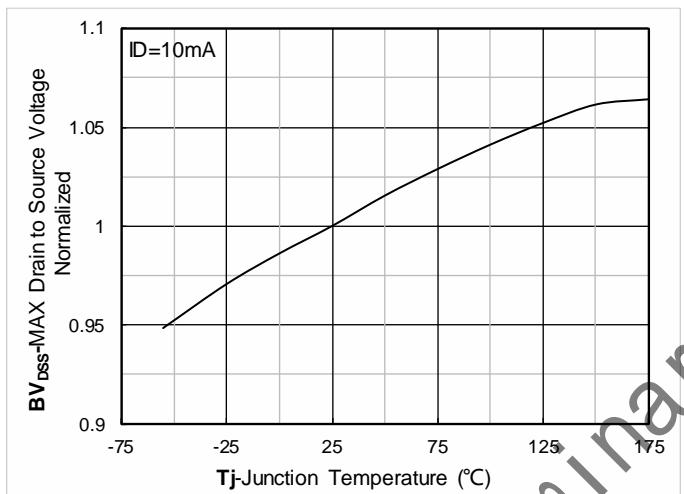


Figure 9. Normalized breakdown voltage

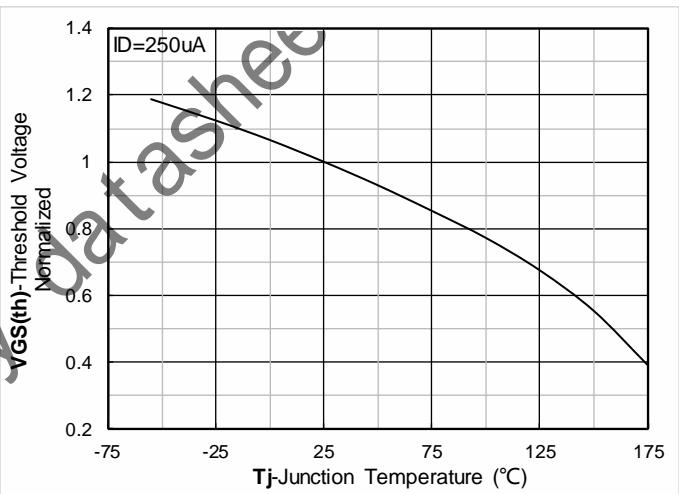


Figure 10. Normalized Threshold voltage

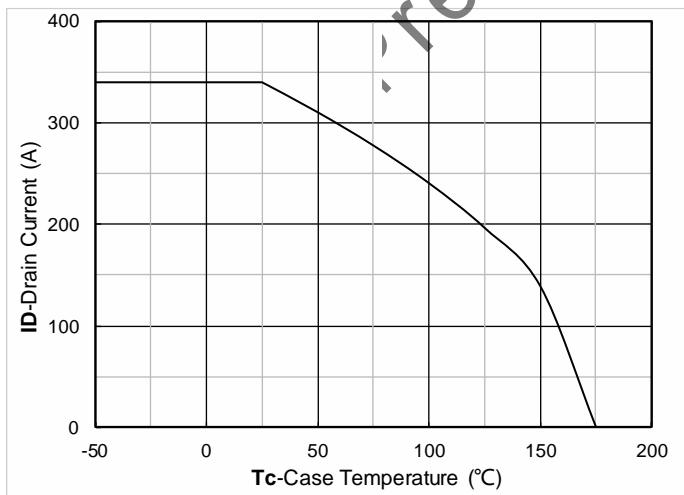


Figure 11. Current dissipation

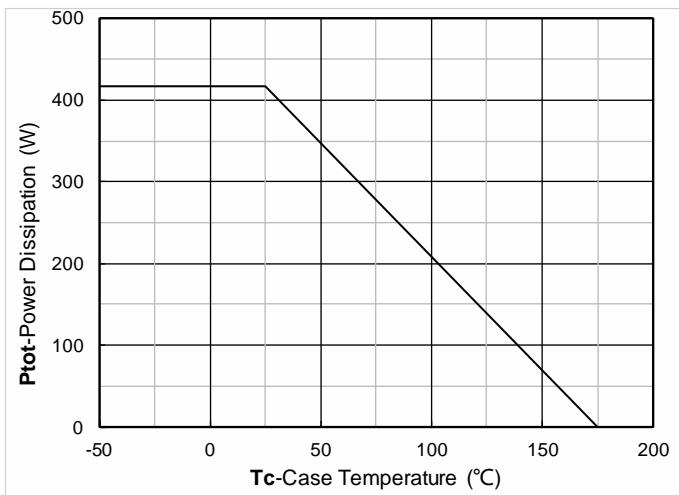


Figure 12. Power dissipation

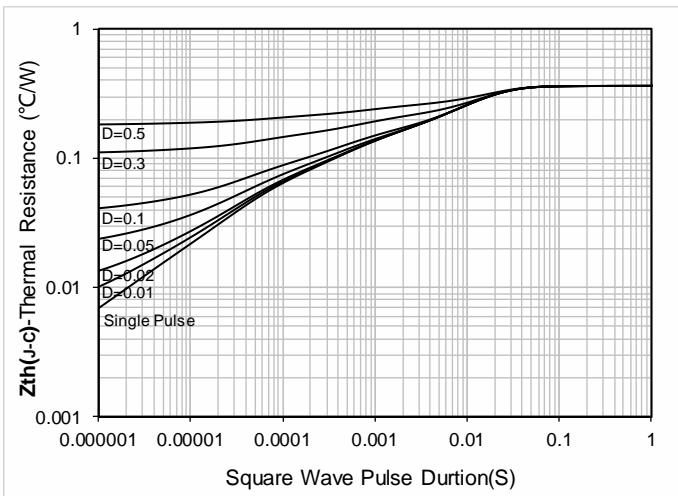


Figure 13. Maximum Transient Thermal Impedance

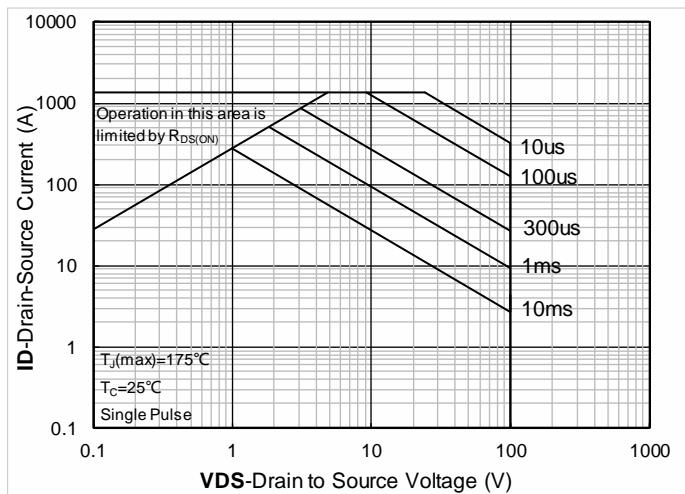


Figure 14. Safe Operation Area

## ■ Test Circuits & Waveforms

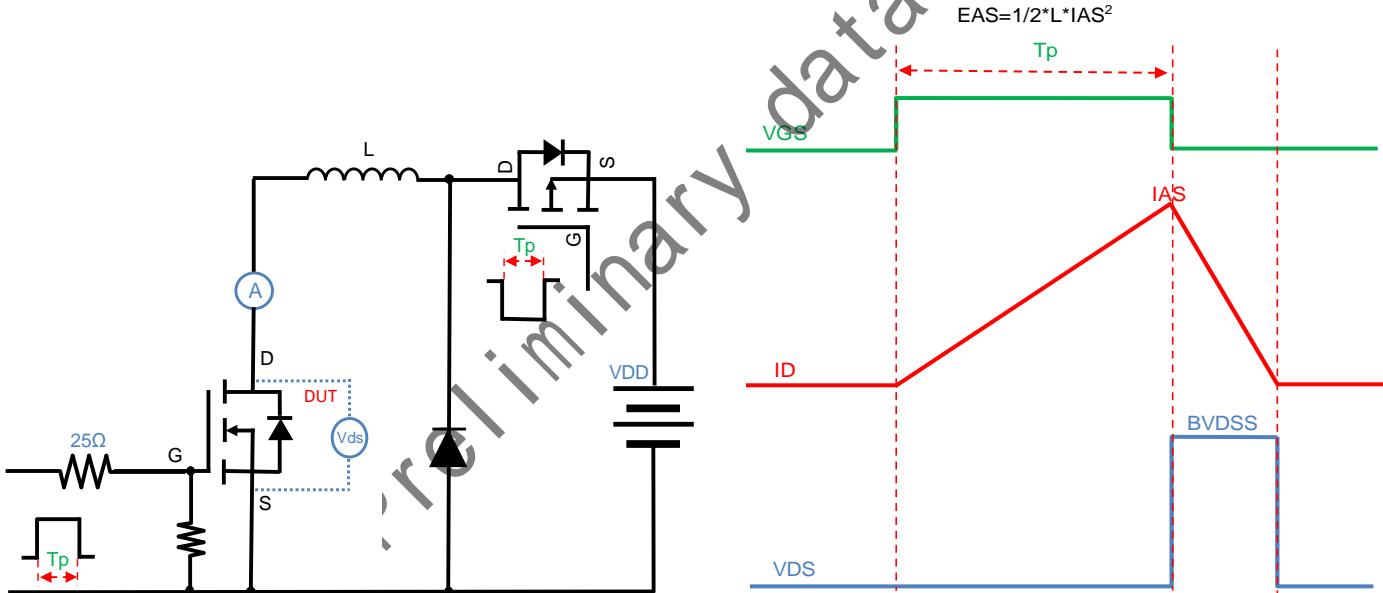


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

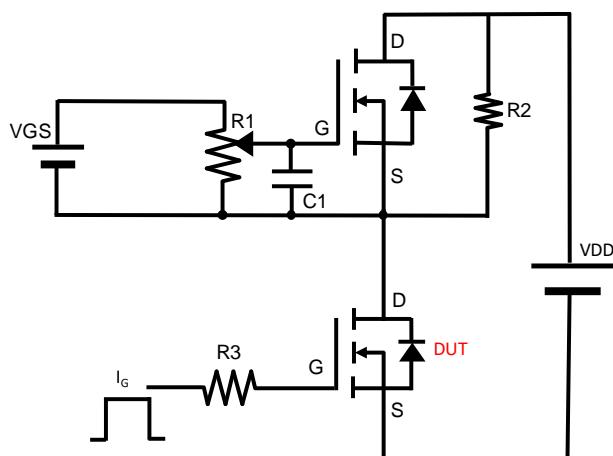


Figure B. Gate Charge Test Circuit & Waveform

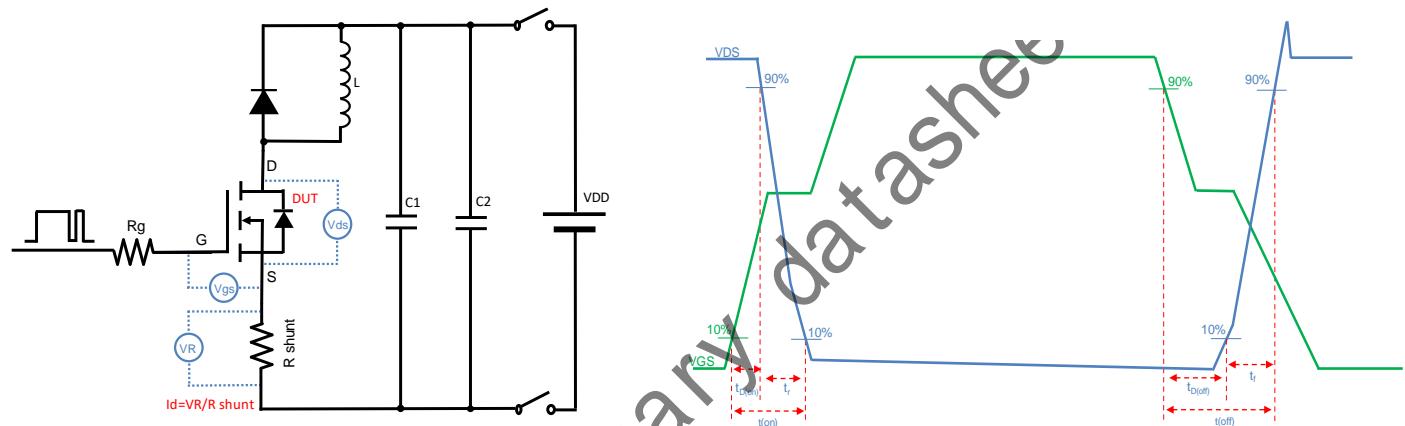


Figure C. Resistive Switching Test Circuit & Waveform

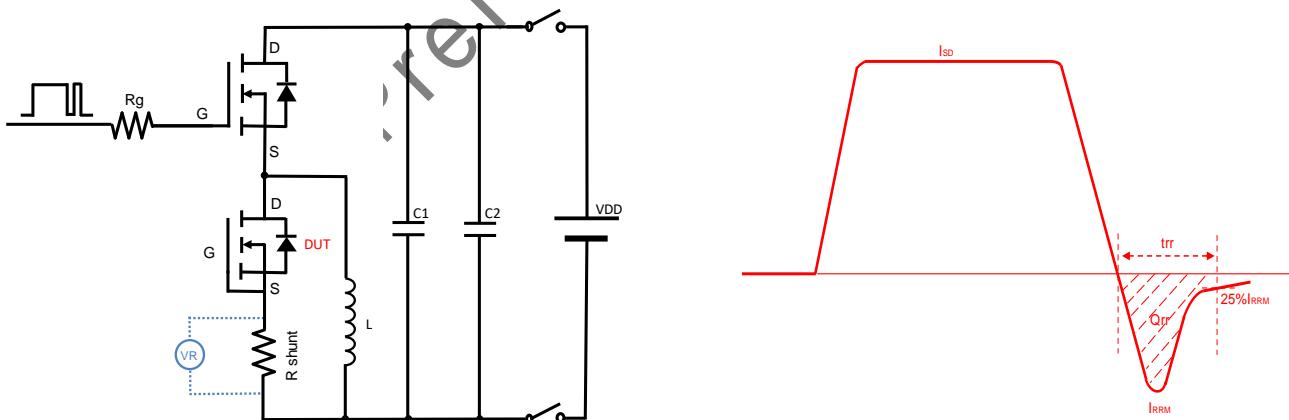


Figure D. Diode Recovery Test Circuit & Waveform



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Preliminary dataset